PCN N	Number:	20220223000.0			PC	N Date:	March 17, 2022	
Title:	Title: HTSSOP Symbolization update for select devices							
Customer Contact:		PCN Manager		Dept:	Quality Services			
Change Type:								
A:	ssembly Site	Assembly Prod		bly Proce	ess ess		Assembly Materials	
Design			Datash	Datasheet			Mechanic	cal Specification
Test Site			Packin	Packing/Shipping/Labeling			Test Prod	cess
Wafer Bump Site			Wafer	Wafer Bump Material			Wafer Bump Process	
	Vafer Fab Site		Wafer	Wafer Fab Materials			Wafer Fab Process	
			Part nu	ımber ch	ange	•		

PCN Details

Description of Change:

This letter is to inform customers of a device symbolization change for select devices in the HTSSOP package that will enable enhanced device traceability.

Device	Current	New			
TPS92381PWPR	92831 \T/ YMSG4 LLLL O \TI/ = TI LOGO YM = YEAR MONTH DATE CODE LLLL = ASSEMBLY LOT CODE S = ASSEMBLY SITE CODE O = PIN 1 (DIMPLE)	92381 \text{\tint{\text{\tint{\text{\tin\text{\t			
TPS92380PWPR	92830 \T/ YMSG4 LLLL O \TI/ = TI LOGO YM = YEAR MONTH DATE CODE LLLL = ASSEMBLY LOT CODE S = ASSEMBLY SITE CODE O = PIN 1 (DIMPLE)	92380 \text{\tint{\text{\tint{\text{\tin\text{\t			

Reason for Change:

Improved Device traceability

Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):

None

Changes to product identification resulting from this PCN:

Device symbolization

Product Affected:

TPS92381PWPR	TPS92380PWPR
IFSSZSOIFWEN	

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_www_admin_team@list.ti.com

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